

### Features

- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant(Note 1) ("P" Suffix Designates Compliant. See Ordering Information)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Low Switching Losses and High Efficiency
- Low Reverse Leakage
- Ultrafast Recovery Time
- Planar Structure Die and Soft Recovery Characteristics

## Maximum Ratings @ 25°C (Unless Otherwise Specified)

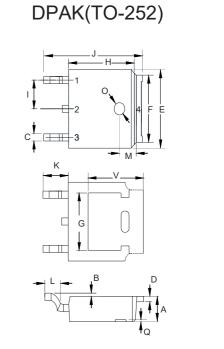
Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>		
Working Peak Reverse Voltage	V <sub>RWM</sub>	600	V
DC Blocking Voltage	V <sub>R</sub>		
RMS Reverse Voltage	V <sub>RMS</sub>	420	V
Average Rectified Forward Current			
Per Diode Per Device	I <sub>F(AV)</sub>	8 16	A
Non-Repetitive Peak Surge Current @8.3ms Half Sine Wave	I <sub>FSM</sub>	100	А
Current Squared Time @ 1ms≤t≤8.3ms	l <sup>2</sup> t	41	A <sup>2</sup> s

### **Internal Structure**

Pin	Description	Simplified Outline	Graphic Symbol
2&4	Cathode		
1&3	Anode	MCC.	1 ⊶▶
		MURSD1660CTA	3 •

Note :1. High Temperature Solder Exemption Applied, See EU Directive Annex 7a.

# 16 Amp FRED Rectifiers 600 Volts



DIMENSIONS					
DIM	INCHES		MM		NOTE
DIN	MIN	MAX	MIN	MAX	NOTE
А	0.087	0.094	2.20	2.40	
В	0.000	0.005	0.00	0.13	
С	0.026	0.034	0.66	0.86	
D	0.018	0.023	0.46	0.58	
E	0.256	0.264	6.50	6.70	
F	0.201	0.215	5.10	5.46	
G	0.190		4.83		
Н	0.236	0.244	6.00	6.20	
I	0.086	0.094	2.18	2.39	
J	0.386	0.409	9.80	10.40	
K	0.1	14	2.90		
L	0.055	0.067	1.40	1.70	
М	0.063		1.60		
0	0.043	0.051	1.10	1.30	
Q	0.000	0.012	0.00	0.30	
V	0.211		5.	35	



### **Thermal characteristics**

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
TJ	Operating Junction Temperature Range		-55		175	°C
T <sub>stg</sub>	Storage Temperature Range		-55		175	°C
Rth <sub>(J-C)</sub>	Thermal Resistance from Junction to Case			3		°C/W
Rth <sub>(J-A)</sub>	Thermal Resistance from Junction to Ambient			40		°C/W

# Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =8A;T <sub>J</sub> =25°C		1.40	1.60	V
		I <sub>F</sub> =8A;T <sub>J</sub> =150°C		1.20	1.30	v
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =600V;T <sub>J</sub> =25°C			5	uA
		V <sub>R</sub> =600V;T <sub>J</sub> =150°C			200	uA
Junction Capacitance	CJ	V <sub>R</sub> =4V;f=1MHz;T <sub>J</sub> =25°C		35		pF

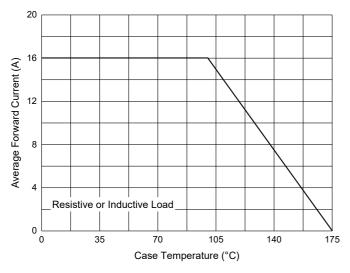
#### Dynamic Recovery Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
		I <sub>F</sub> =0.5A; I <sub>R</sub> =1.0A;I <sub>RR</sub> =0.25A			20	35	
Reverse Recovery Time	e Recovery Time t <sub>rr</sub>		TJ=25°C		82		ns
		I <sub>F</sub> =8A d <sub>iF</sub> /d <sub>t</sub> =-200A/μs V <sub>RM</sub> =400V	T <sub>J</sub> =150°C		125		
Peak Recovery Current	I <sub>RRM</sub>		TJ=25°C		3.45		- A
			T <sub>J</sub> =150°C		6.65		
Reverse Recovery Charge	Q <sub>rr</sub>		TJ=25°C		140		nC
			T <sub>J</sub> =150°C		420		10



## **Curve Characteristics**





#### Fig. 3 - Typical Forward Characteristics

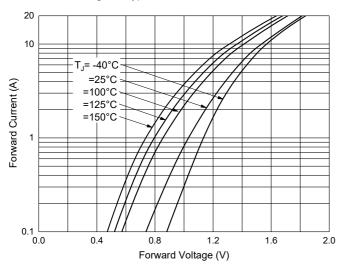
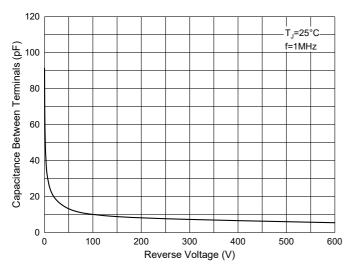


Fig. 5 - Typical Capacitance Characteristics



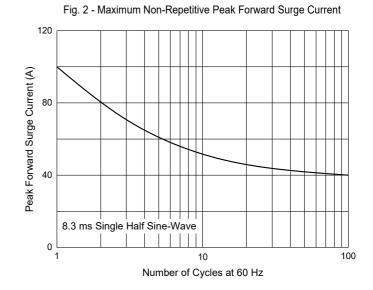


Fig. 4 - Typical Reverse Leakage Characteristics

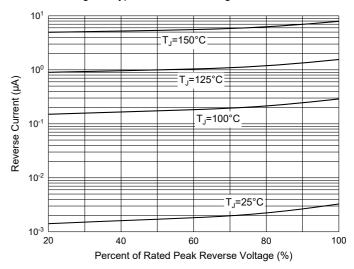
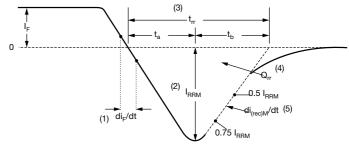


Fig. 6 - Reverse Recovery Waveform and Definitions



- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3) t<sub>rr</sub> reverse recovery time measured from zero crossing point of negative going I<sub>F</sub> to point where a line passing through 0.75 I<sub>RRM</sub> and 0.50 I<sub>RRM</sub> extrapolated to zero current.

(4)  $\mathbf{Q}_{rr}$  - area under curve defined by  $\mathbf{t}_{rr}$  and  $\mathbf{I}_{\text{RRM}}$ 



(5)  $di_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$ 



### **Ordering Information**

Device	Packing
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel

Note : Adding "-HF" Suffix For Halogen Free, eg. Part Number-TP-HF

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